

ภาคผนวก ก

คู่มือใช้งานของบอร์ดไมโครคอนโทรลเลอร์



PIC18F2331/2431/4331/4431

28/40/44-Pin Enhanced Flash Microcontrollers with nanoWatt Technology, High-Performance PWM and A/D

14-Bit Power Control PWM Module:

- Up to 4 Channels with Complementary Outputs
- Edge or Center-Aligned Operation
- Flexible Dead-Band Generator
- Hardware Fault Protection Inputs
- Simultaneous Update of Duty Cycle and Period:
 - Flexible Special Event Trigger output

Motion Feedback Module:

- Three Independent Input Capture Channels:
 - Flexible operating modes for period and pulse-width measurement
 - Special Hall sensor interface module
 - Special Event Trigger output to other modules
- Quadrature Encoder Interface:
 - 2-phase inputs and one index input from encoder
 - High and low position tracking with direction status and change of direction interrupt
 - Velocity measurement

High-Speed, 200 ksp/s 10-Bit A/D Converter:

- Up to 9 Channels
- Simultaneous, Two-Channel Sampling
- Sequential Sampling, 1, 2 or 4 Selected Channels
- Auto-Conversion Capability
- 4-Word FIFO with Selectable Interrupt Frequency
- Selectable External Conversion Triggers
- Programmable Acquisition Time

Flexible Oscillator Structure:

- Four Crystal modes up to 40 MHz
- Two External Clock modes up to 40 MHz
- Internal Oscillator Block:
 - 8 user-selectable frequencies: 31 kHz to 8 MHz
 - OSCTUNE can compensate for frequency drift
- Secondary Oscillator using Timer1 @ 32 kHz
- Fail-Safe Clock Monitor:
 - Allows for safe shutdown of device if clock fails

Power-Managed Modes:

- Run: CPU on, Peripherals on
- Idle: CPU off, Peripherals on
- Sleep: CPU off, Peripherals off
- Ultra Low, 50 nA Input Leakage
- Idle mode Currents Down to 5.8 μ A, Typical
- Sleep Current Down to 0.1 μ A, Typical
- Timer1 Oscillator, 1.8 μ A, Typical, 32 kHz, 2V
- Watchdog Timer (WDT), 2.1 μ A, typical
- Oscillator Two-Speed Start-up:
 - Fast wake from Sleep and Idle, 1 μ s, typical

Peripheral Highlights:

- High-Current Sink/Source 25 mA/25 mA
- Three External Interrupts
- Two Capture/Compare/PWM (CCP) modules
- Enhanced USART module:
 - Supports RS-485, RS-232 and LIN/J2602
 - Auto-wake-up on Start bit
 - Auto-Baud Detect

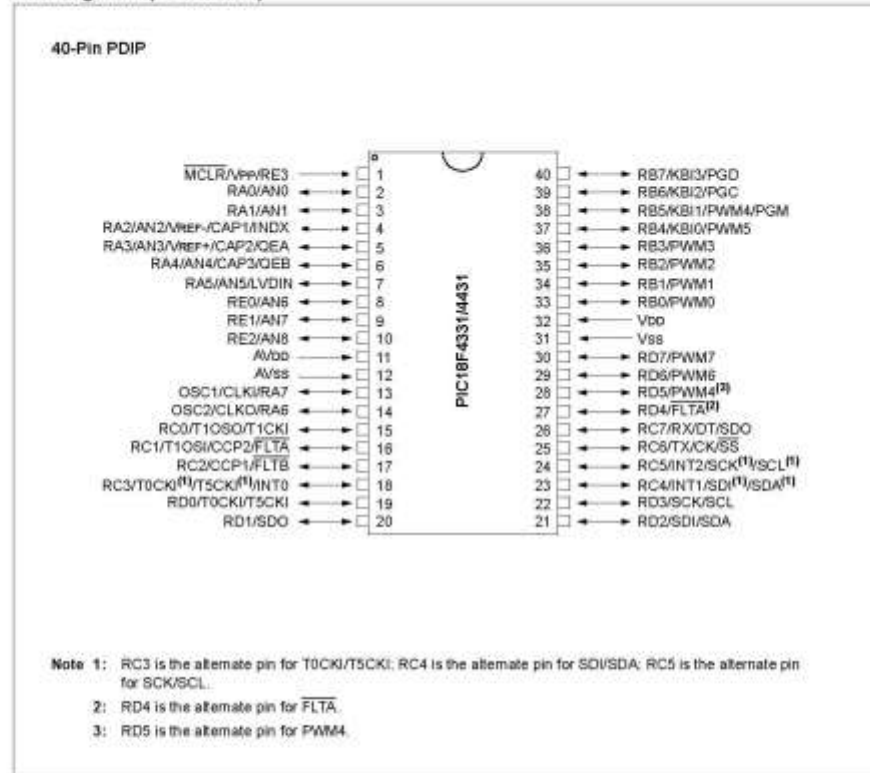
Special Microcontroller Features:

- 100,000 Erase/Write Cycle Enhanced Flash Program Memory, Typical
- 1,000,000 Erase/Write Cycle Data EEPROM Memory, Typical
- Flash/Data EEPROM Retention: 100 Years
- Self-Programmable under Software Control
- Priority Levels for Interrupts
- 8 x 8 Single-Cycle Hardware Multiplier
- Extended Watchdog Timer (WDT):
 - Programmable period from 41 ms to 131s
- Single-Supply In-Circuit Serial Programming™ (ICSP™) via Two Pins
- In-Circuit Debug (ICD) via Two Pins:
 - Drives PWM outputs safely when debugging

Device	Program Memory		Data Memory		I/O	10-Bit A/D (ch)	CCP	SSP		EUSART	Quadrature Encoder	14-Bit PWM (ch)	Timers 8/16-Bit
	Flash (bytes)	#Single-Word Instructions	SRAM (bytes)	EEPROM (bytes)				SP1	Slave I ² C™				
PIC18F2331	8192	4096	768	256	24	5	2	Y	Y	Y	Y	8	1/3
PIC18F2431	16384	8192	768	256	24	5	2	Y	Y	Y	Y	8	1/3
PIC18F4331	8192	4096	768	256	36	9	2	Y	Y	Y	Y	8	1/3
PIC18F4431	16384	8192	768	256	36	9	2	Y	Y	Y	Y	8	1/3

PIC18F2331/2431/4331/4431

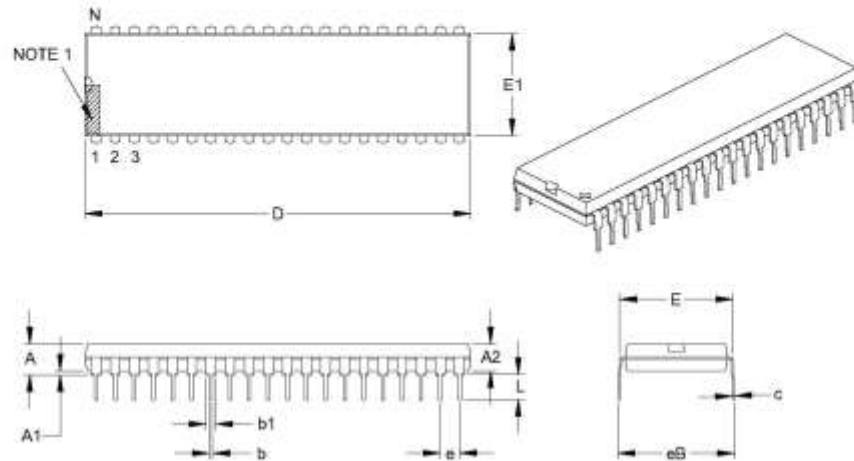
Pin Diagrams (Continued)



PIC18F2331/2431/4331/4431

40-Lead Plastic Dual In-Line (P) – 600 mil Body [PDIP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Dimension Limits	Units	INCHES		
		MIN	NOM	MAX
Number of Pins	N		40	
Pitch	e		100 BSC	
Top to Seating Plane	A	–	–	.250
Molded Package Thickness	A2	.125	–	.195
Base to Seating Plane	A1	.015	–	–
Shoulder to Shoulder Width	E	.590	–	.625
Molded Package Width	E1	.485	–	.580
Overall Length	D	1.980	–	2.095
Tip to Seating Plane	L	.115	–	.200
Lead Thickness	c	.008	–	.015
Upper Lead Width	b1	.030	–	.070
Lower Lead Width	b	.014	–	.023
Overall Row Spacing §	eB	–	–	.700

Notes:

- Pin 1 visual index feature may vary, but must be located within the hatched area.
- § Significant Characteristic.
- Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" per side.
- Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-0168